



Dimensions	
Footprint	3216
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
H	1.6mm +/-0.2mm
S	0.8mm +/-0.3mm
F	1.2mm +/-0.1mm
K	1.3mm TYP

Packaging Specifications	
Packaging	T&R, 330mm
Packaging Quantity	9000

General Information	
Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, Molded
RoHS	Yes
Termination	Tin
AEC-Q200	No
Notes	Obsolete. Old Part Number [Obsolete] Was B45196H5225M106.

Specifications	
Capacitance	2.2 uF
Capacitance Tolerance	20%
Voltage DC	25 VDC (85C), 16.75 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	6%
Failure Rate	N/A
Leakage Current	0.6 uA

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